Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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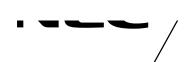


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DATA SHEET



MOS FIELD EFFECT TRANSISTOR

NP80N055ELE, NP80N055KLE NP80N055CLE, NP80N055DLE, NP80N055MLE, NP80N055NLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

ORDERING INFORMATION

| PART NUMBER | LEAD PLATING | PACKING | PACKAGE | |
|-----------------------------|---------------|-----------------|-----------------------------------|--|
| NP80N055ELE-E1-AY Note1, 2 | | | TO-263 (MP-25ZJ) typ. 1.4 g | |
| NP80N055ELE-E2-AY Note1, 2 | Pure Sn (Tin) | Tana 200 n/raal | | |
| NP80N055KLE-E1-AY Note1 | | Tape 800 p/reel | TO 200 (MD 257K) him 4.5 m | |
| NP80N055KLE-E2-AY Note1 | | | TO-263 (MP-25ZK) typ. 1.5 g | |
| NP80N055CLE-S12-AZ Note1, 2 | Sn-Ag-Cu | | TO-220 (MP-25) typ. 1.9 g | |
| NP80N055DLE-S12-AY Note1, 2 | | Tuba 50 a /b da | TO-262 (MP-25 Fin Cut) typ. 1.8 g | |
| NP80N055MLE-S18-AY Note1 | Pure Sn (Tin) | Tube 50 p/tube | TO-220 (MP-25K) typ. 1.9 g | |
| NP80N055NLE-S18-AY Note1 | | | TO-262 (MP-25SK) typ. 1.8 g | |

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Not for new design

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{DS(on)1} = 11 \text{ m}\Omega$ MAX. (Vgs = 10 V, ID = 40 A)

 $R_{DS(on)2}$ = 13 $m\Omega$ MAX. (VGS = 5 V, ID = 40 A)

 $R_{DS(on)3}$ = 15 m Ω MAX. (VGS = 4.5 V, ID = 40 A)

• Low input capacitance

Ciss = 2900 pF TYP.

• Built-in gate protection diode

(TO-220)



(TO-262)



(TO-263)



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sales representative for availability and additional information.



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| Drain to Source Voltage (VGS = 0 V) | VDSS | 55 | V |
|---|-----------------------|-------------|----|
| Gate to Source Voltage (VDS = 0 V) | Vgss | ±20 | V |
| Drain Current (DC) (Tc = 25°C) Note1 | ID(DC) | ±80 | Α |
| Drain Current (Pulse) Note2 | I _{D(pulse)} | ±200 | Α |
| Total Power Dissipation (Tc = 25°C) | Рт | 120 | W |
| Total Power Dissipation (T _A = 25°C) | Рт | 1.8 | W |
| Channel Temperature | Tch | 175 | °C |
| Storage Temperature | Tstg | -55 to +175 | °C |
| Single Avalanche Current Note3 | las | 45/30/10 | Α |
| Single Avalanche Energy Note3 | Eas | 2.0/90/100 | mJ |

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

- **2.** PW \leq 10 μ s, Duty cycle \leq 1%
- 3. Starting T_{ch} = 25°C, V_{DD} = 28 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see Figure 4.)

THERMAL RESISTANCE

| Channel to Case Thermal Resistance | Rth(ch-C) | 1.25 | °C/W |
|---------------------------------------|-----------|------|------|
| Channel to Ambient Thermal Resistance | Rth(ch-A) | 83.3 | °C/W |

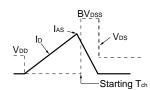


ELECTRICAL CHARACTERISTICS (TA = 25°C)

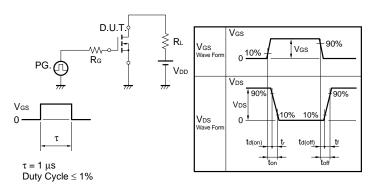
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|---------------------|---|------|------|------|------|
| Zero Gate Voltage Drain Current | Ipss | V _{DS} = 55 V, V _{GS} = 0 V | | | 10 | μА |
| Gate Leakage Current | Igss | V _{GS} = ±20 V, V _{DS} = 0 V | | | ±10 | μА |
| Gate to Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1.5 | 2.0 | 2.5 | V |
| Forward Transfer Admittance | yfs | V _{DS} = 10 V, I _D = 40 A | 15 | 40 | | S |
| Drain to Source On-state Resistance | RDS(on)1 | V _{GS} = 10 V, I _D = 40 A | | 8.4 | 11 | mΩ |
| | RDS(on)2 | V _{GS} = 5 V, I _D = 40 A | | 10.3 | 13 | mΩ |
| | RDS(on)3 | V _{GS} = 4.5 V, I _D = 40 A | | 11.3 | 15 | mΩ |
| Input Capacitance | Ciss | V _{DS} = 25 V, | | 2900 | 4400 | pF |
| Output Capacitance | Coss | V _{GS} = 0 V, | | 380 | 570 | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 170 | 310 | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 28 V, I _D = 40 A, | | 22 | 48 | ns |
| Rise Time | tr | V _{GS} = 10 V, | | 10 | 25 | ns |
| Turn-off Delay Time | t _{d(off)} | R _G = 1 Ω | | 62 | 120 | ns |
| Fall Time | tf | | | 11 | 27 | ns |
| Total Gate Charge | Q _{G1} | V _{DD} = 44 V, V _{GS} = 10 V, I _D = 80 A | | 50 | 75 | nC |
| | Q _{G2} | V _{DD} = 44 V, | | 26 | 39 | nC |
| Gate to Source Charge | QGS | V _{GS} = 5 V, | | 12 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 80 A | | 15 | | nC |
| Body Diode Forward Voltage | V _{F(S-D)} | I _F = 80 A, V _{GS} = 0 V | | 1.0 | | V |
| Reverse Recovery Time | trr | IF = 80 A, VGS = 0 V, | | 50 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = 100 A/μs | | 100 | | nC |

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{\text{GS}} = 20 \rightarrow 0 \text{ V}$



TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} D.U.T. \\ \hline \\ I_G = 2 \text{ mA} \\ \hline \\ V_{OD} \\ \hline \end{array}$$

TYPICAL CHARACTERISTICS (TA = 25°C)

Figure 1. DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

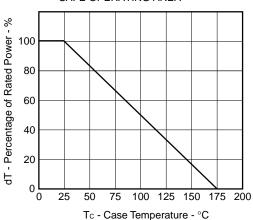


Figure3. FORWARD BIAS SAFE OPERATING AREA

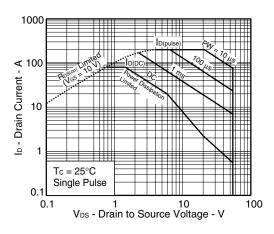


Figure 2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

140

120

100

80

60

80

0

0

25

50

75

100

125

150

175

200

Figure 4. SINGLE AVALANCHE ENERGY DERATING FACTOR

Tc - Case Temperature - °C

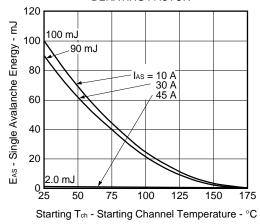


Figure 5. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

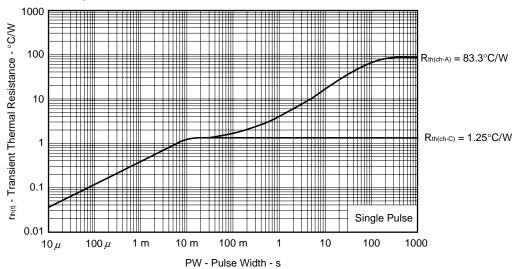


Figure 6. FORWARD TRANSFER CHARACTERISTICS

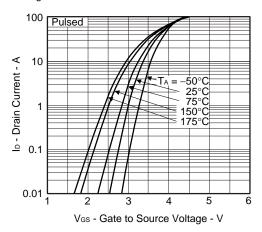


Figure 8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

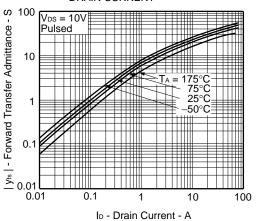


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

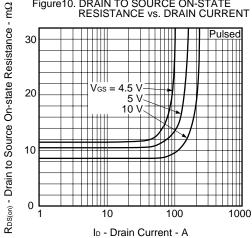


Figure7. DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

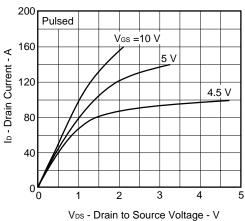


Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

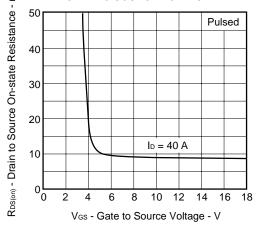
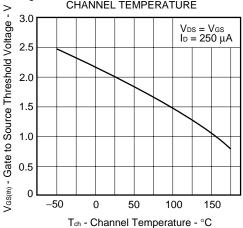


Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - Drain to Source On-state Resistance - $m\Omega$

Figure 12. DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

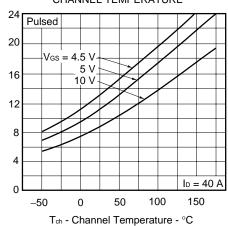


Figure13. SOURCE TO DRAIN DIODE FORWARD VOLTAGE

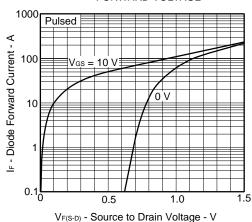


Figure14. CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

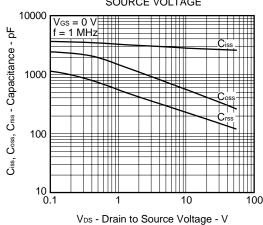


Figure 15. SWITCHING CHARACTERISTICS

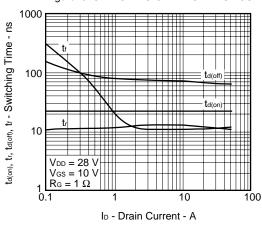


Figure 16. REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

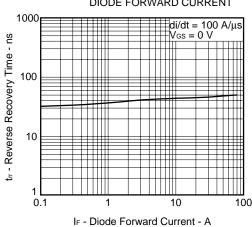
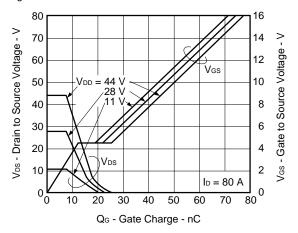
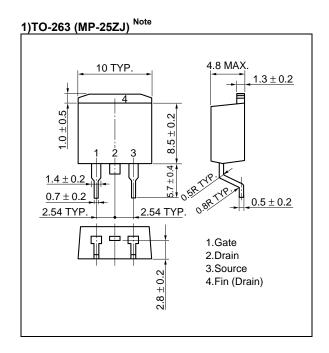
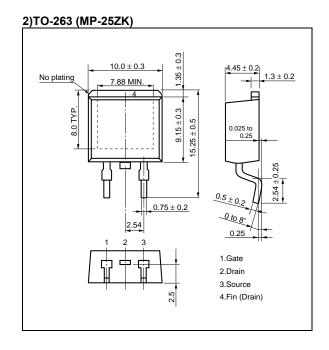


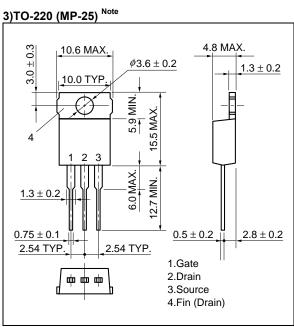
Figure 17. DYNAMIC INPUT/OUTPUT CHARACTERISTICS

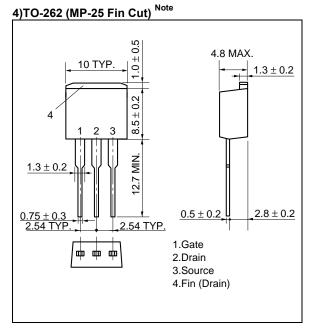


<R> PACKAGE DRAWINGS (Unit: mm)

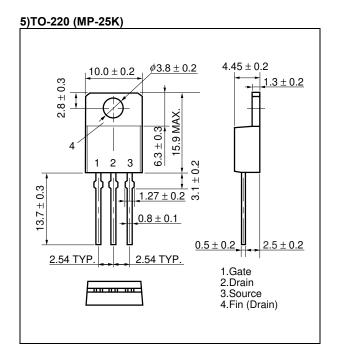


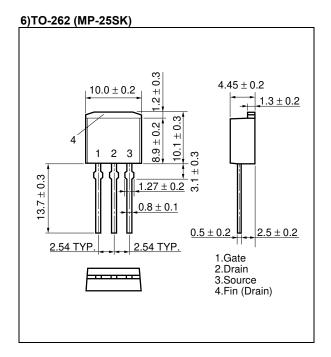




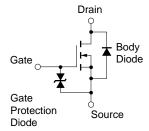


Note Not for new design





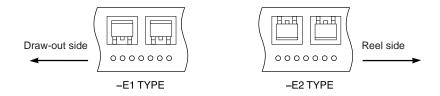
EQUIVALENT CIRCUIT



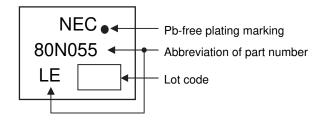
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

<R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



<R> MARKING INFORMATION



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These products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

| Soldering Method | Soldering Conditions | Recommended Condition Symbol | |
|-------------------------|--|------------------------------|--|
| Infrared reflow | Maximum temperature (Package's surface temperature): 260°C or below | | |
| MP-25ZJ, MP-25ZK | Time at maximum temperature: 10 seconds or less | | |
| | Time of temperature higher than 220°C: 60 seconds or less | JD00 00 0 | |
| | Preheating time at 160 to 180°C: 60 to 120 seconds | IR60-00-3 | |
| | Maximum number of reflow processes: 3 times | | |
| | Maximum chlorine content of rosin flux (percentage mass): 0.2% or less | | |
| Wave soldering | Maximum temperature (Solder temperature): 260°C or below | | |
| MP-25, MP-25K, MP-25SK, | Time: 10 seconds or less | THDWS | |
| MP-25 Fin Cut | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |
| Partial heating | Maximum temperature (Pin temperature): 350°C or below | | |
| MP-25ZJ, MP-25ZK, | Time (per side of the device): 3 seconds or less | P350 | |
| MP-25K, MP-25SK | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |
| Partial heating | Maximum temperature (Pin temperature): 300°C or below | | |
| MP-25, MP-25 Fin Cut | Time (per side of the device): 3 seconds or less | P300 | |
| | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |

Caution Do not use different soldering methods together (except for partial heating).

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